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'90A, 'LS90 . . . Decade Counters

'92A, 'LS92 . . . Divide By-Twelve Counters

'93A, 'LS93 . . . 4-Bit Binary Counters

T\/050	TYPICAL
TYPES	POWER DISSIPATION
'90A	145 mW
'92A, '93A	130 mW
LS90, LS92, LS93	45 mW

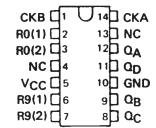
#### description

Each of these monolithic counters contains four master-slave flip-flops and additional gating to provide a divide-by-two counter and a three-stage binary counter for which the count cycle length is divide-by-five for the '90A and 'LS90, divide-by-six for the '92A and 'LS92, and the divide-by-eight for the '93A and 'LS93.

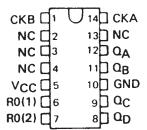
All of these counters have a gated zero reset and the '90A and 'LS90 also have gated set-to-nine inputs for use in BCD nine's complement applications.

To use their maximum count length (decade, divide-by-twelve, or four-bit binary) of these counters, the CKB input is connected to the  $\Omega_A$  output. The input count pulses are applied to CKA input and the outputs are as described in the appropriate function table. A symmetrical divide-by-ten count can be obtained from the '90A or 'LS90 counters by connecting the  $\Omega_D$  output to the CKA input and applying the input count to the CKB input which gives a divide-by-ten square wave at output  $\Omega_A$ .

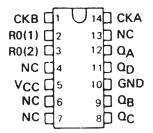
SN5490A, SN54LS90 . . . J OR W PACKAGE SN7490A . . . N PACKAGE SN74LS90 . . . D OR N PACKAGE (TOP VIEW)



SN5492A, SN54LS92 . . . J OR W PACKAGE SN7492A . . . N PACKAGE SN74LS92 . . . D OR N PACKAGE (TOP VIEW)

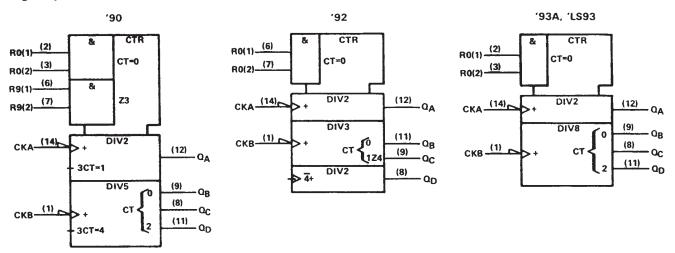


SN5493A, SN54LS93 . . . J OR W PACKAGE SN7493 . . . N PACKAGE SN74LS93 . . . D OR N PACKAGE (TOP VIEW)



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### logic symbols†



<sup>&</sup>lt;sup>†</sup>These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.



'90A, 'LS90 BCD COUNT SEQUENCE

(See Note A)

COUNT		OUT	PUT	
COON	ap	QC	OΒ	QA
0	L	L	L	L
1	L	L	L	н
2	L	L	н	L
3	Ĺ	L	Н	н
4	L	Н	L	L
5	L	Н	L	н
6	L	н	Н	L
7	L	Н	Н	н
8	н	L	L	L
9	Н	L	L	н

'92A, 'LS92 COUNT SEQUENCE

(See Note C)

COUNT		OUT	PUT	
COONT	$a_{D}$	$\alpha_{C}$	QB	QA
0	L	L	L	L
1	L	L	L	н
2	L	L	Н	L
3	L	Ł	Н	Н
4	L	Н	L	L
5	L	Н	L	н
6	н	Ł	L	L
7	н	L	L	н
8	н	L	Н	L
9	н	L	Н	н
10	н	Н	L	L
11	н	Н	L	н

'92A, 'LS92, '93A, 'LS93 RESET/COUNT FUNCTION TABLE

RESET	INPUTS		OUT	PUT	
R <sub>0(1)</sub>	R <sub>0(2)</sub>	α <sub>D</sub>	$\alpha_{C}$	$o_{B}$	QA
Н	Н	L	L	L	L
L	X		COL	JNT	
×	L		COL	TNL	

NOTES: A. Output  $\Omega_{\mbox{\scriptsize A}}$  is connected to input CKB for BCD count.

- B. Output  $\mathbf{Q}_{D}$  is connected to input CKA for bi-quinary count.
- C. Output  $Q_A$  is connected to input CKB.
- D. H = high level, L = low level, X = irrelevant

'90A, 'LS90 BI-QUINARY (5-2)

#### (See Note B)

COUNT	OUTPUT												
COONT	QA	α <sub>D</sub>	ac	OΒ									
0	L	L	L	L									
1	L	L	L	н									
2	L	L	Н	L									
3	L	L	Н	н									
4	L	Н	L	L									
5	н	L	L	L									
6	н	L	L	н									
7	н	L	Н	L									
8	н	L	Н	Н									
9	н	Н	L	L									

'90A, 'LS90 RESET/COUNT FUNCTION TABLE

1	RESET	3	OUTPUT									
R <sub>0(1)</sub>	R <sub>0(2)</sub>	R <sub>9(1)</sub>	R9(2)	$\sigma_{D}$	QC	αB	QA					
Н	Н	L	Х	L	L	L	L					
Н	H	X	L	L	L	L	L					
X	×	Н	н	н	L	L	Н					
Х	L	×	L		CO	UNT						
L	×	L	Х		СО	UNT						
L	×	Х	L	COUNT								
×	L	L	х	COUNT								

#### '93A, 'LS93 COUNT SEQUENCE

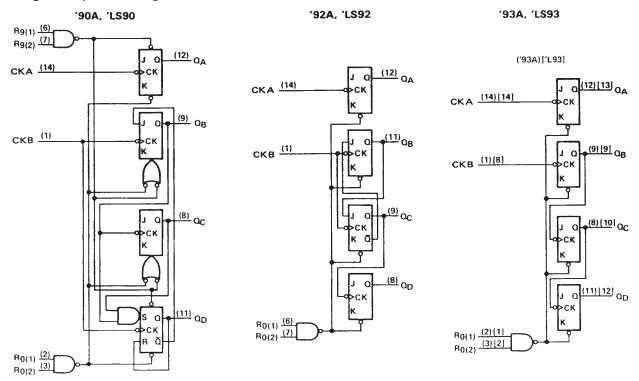
#### (See Note C)

(See Note C)													
COUNT		ουτ	PUT										
COOK	QD	$\mathbf{a}_{\mathbf{C}}$	QB	QA									
0	L	L	L	L									
1	L	L	L	Н									
2	L	L	Н	L									
3	L	L	Н	Н									
4	L	Н	L	L									
5	L	Н	L	H									
6	L	Н	Н	L									
7	L	Н	Н	Н									
8	н	L	L	L									
9	н	L	L	Н									
10	н	L	Н	L									
11	н	L	Н	Н									
12	н	Н	L	L									
13	н	Н	L	Н									
14	н	Н	Н	L									
15	н	Н	Н	Н									



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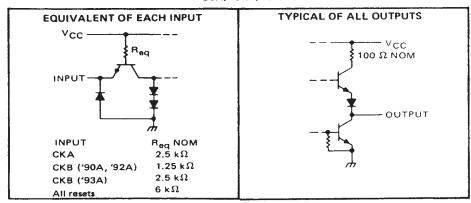
#### logic diagrams (positive logic)



The J and K inputs shown without connection are for reference only and are functionally at a high level. Pin numbers shown in () are for the 'LS93 and '93A and pin numbers shown in () are for the 54L93.

### schematics of inputs and outputs

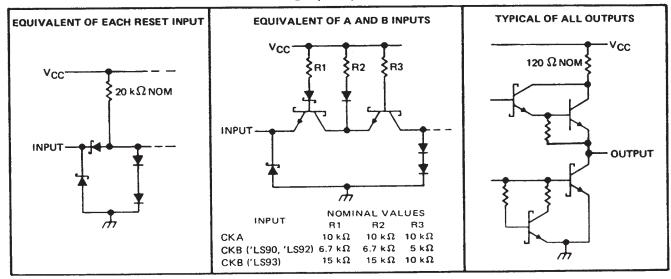
'90A, '92A, '93A



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#### schematics of inputs and outputs (continued)

'LS90, 'LS92, 'LS93



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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)											7 V
Input voltage											5.5 V
Interemitter voltage (see Note 2)											5.5 V
Operating free-air temperature range:	SN5490A, S	SN5492A	SN5493A						–55°C	to '	125°C
Special and a service and a se	SN7490A, S	SN7492A	SN7493A						. 0°0	C to	70°C
Storage temperature range											

NOTES: 1. Voltage values, except interemitter voltage, are with respect to network ground terminal.

This is the voltage between two emitters of a multiple-emitter transistor. For these circuits, this rating applies between the two R<sub>0</sub> inputs, and for the '90A circuit, it also applies between the two R<sub>9</sub> inputs.

### recommended operating conditions

		i	00A, SN SN5493		SN749	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, VCC		4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH		_	-800			-800	μΑ	
Low-level output current, IOL			16			16	mA	
	A input	0		32	0		32	MHz
Count frequency, f <sub>count</sub> (see Figure 1)	B input	0		16	0		16	1411.12
	A input	15			15			
Pulse width, tw	8 input	30			30			ns
• ••	Reset inputs	15			15			
Reset inactive-state setup time, t <sub>SU</sub>		25			25			ns
Operating free-air temperature, TA	-55		125	0		70	°c	

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

						'90A			'92A			'93A		UNIT
	PARAMETE	R <sup>¶</sup>	TEST CONDIT	TIONST	MIN	TYP#	MAX	MIN	TYP <sup>‡</sup>	MAX	MIN	TYP <sup>‡</sup>	MAX	ONT
VIH	High-level inpu	ıt voltage			2			2			2			V
VIL	Low-level inpu						0.8			0.8			8.0	V
VIK	Input clamp vo		VCC = MIN, II = -	-12 mA			-1.5			-1.5			-1.5	V
	High-level outp		V <sub>CC</sub> = MIN, V <sub>IH</sub> V <sub>IL</sub> = 0.8 V, I <sub>OH</sub>		2.4	3.4		2.4	3.4		2.4	3.4		V
VOL	Low-level outp	out voltage	V <sub>CC</sub> = MIN, V <sub>IH</sub>	= 2 V,		0.2	0.4		0.2	0.4		0.2	0.4	V
1,	Input current maximum inpu		V <sub>CC</sub> = MAX, V <sub>1</sub> =	5.5 V			1			1			1	mA
		Any reset					40			40			40	1
ίн	High-level	CKA	VCC = MAX, VI =	2.4 V			80			80			80	μΑ
1111	input current	СКВ					120			120			80	
		Any reset					-1.6			-1.6			-1.6	
IIL.	Low-level	CKA	VCC = MAX, VI =	0.4 V			-3.2			-3.2			-3.2	mA
11	input current	СКВ	- VCC - W/A A, V   - 0.4 V				-4.8			-4.8			-3.2	
	Short-circuit		SN54'		-20		-57	-20		-57	-20		-57	- mA
los	output curren	t §	VCC = MAX	SN74'	-18		-57	-18		-57	-18		-57	
¹cc	Supply curren		V <sub>CC</sub> = MAX, See Note 3			29	42		26	39		26	39	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 3: I<sub>CC</sub> is measured with all outputs open, both R<sub>0</sub> inputs grounded following momentary connection to 4.5 V, and all other inputs grounded.



 $<sup>^{\</sup>ddagger}$ All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_{A} = 25^{\circ}\text{C}$ .

SNot more than one output should be shorted at a time.

QA outputs are tested at IOL = 16 mA plus the limit value for IIL for the CKB input. This permits driving the CKB input while maintaining

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# switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$

	FROM TO TEST COND				'90A			'92A			UNIT				
PARAMETER <sup>†</sup>	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	ONT		
	CKA	QA		32	42		32	42		32	42		MHz		
f <sub>max</sub>	СКВ	QB		16			16			16			2		
tPLH	CKA				10	16		10	16		10	16	ns		
tPHL .		QΑ			12	18		12	18		12	18			
tPLH		0			32	48		32	48		46	70	ns		
tPHL	CKA	$\sigma_{D}$			34	50		34	50		46	70			
tPLH			CL = 15 pF,		10	16		10	16		10	16	ns		
tPHL	СКВ	$\sigma_{B}$	R <sub>L</sub> = 400 Ω,		14	21		14	21		14	21	113		
tPLH			See Figure 1		21	32		10	16_		21	32	ns		
tPHL	СКВ	ОC			23	35		14	21		23	35	1,,3		
tPLH		_	1		21	32		21	32		34	51	ns		
tPHL	СКВ	σD			23	35		23	35		34	51	113		
tPHL	Set-to-0	Any			26	40		26	40		26	40	ns		
tPLH		Q <sub>A</sub> , Q <sub>D</sub>	5				20	30							ns
tPHL	Set-to-9	Q <sub>B</sub> , Q <sub>C</sub>	1		26	40									

 $<sup>^{\</sup>dagger}$ f<sub>max</sub> = maximum count frequency



tpLH ≡ propagation delay time, low-to-high-level output

tpHL ≡ propagation delay time, high-to-low-level output

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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)																						7 V
Input voltage: R inputs																						7 V
A and B inputs .																						5.5 V
Operating free-air temperature range	: :	SN	54	LS	" (	Circ	cui	ts										_	55	°C	to	125°C
	:	SN	74	LS	' (	Circ	cui	ts											-	o°(	C t	o 70°C
Storage temperature range																		_(	65	°C	to	150°C

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

		SN54LS90 SN54LS92 SN54LS93			SN74LS90 SN74LS92 SN74LS93			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V <sub>CC</sub>		4.5	5	5.5	4.75	5	5.25	٧
High-level output current, IOH				-400			-400	μА
Low-level output current, IOL				4			8	mA
Count fraguency 6 /con Figure 11	A input	0		32	0		32	MHz
Count frequency, f <sub>count</sub> (see Figure 1)	B input	0		16	0		16	IVITIZ
	A input	15			15			
Pulse width, tw	B input	30			30			ns
	Reset inputs	30			30			1
Reset inactive-state setup time, t <sub>SU</sub>	100	25			25			ns
Operating free-air temperature, TA		-55		125	0		70	°C

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TE	ST CONDITION	S <sup>†</sup>	1	N54LS9 N54LS9		SN74LS90 SN74LS92			UNIT
						MIN	TYP‡	MAX	MIN	TYP‡	MAX	
VIH	High-level inpu	t voltage				2			2			V
VIL	Low-level input	tvoltage						0.7			0.8	V
VIK	Input clamp vo	Itage	V <sub>CC</sub> = MIN,	$I_1 = -18 \text{ mA}$				-1.5			-1.5	V
Vон	High-level outp	ut voltage	V <sub>CC</sub> = MIN, V <sub>IL</sub> = V <sub>IL</sub> max,		Ą	2.5	3.4		2.7	3.4		V
\/-·	Law laval aven		V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	IOL = 4 mA¶		0.25	0.4		0.25	0.4	V
VOL	Low-level outpo	ut voitage	VIL = VIL max,		10L = 8 mA¶					0.35	0.5	\ \ \
	Input current	Any reset	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 7 V				0.1			0.1	
11	at maximum	CKA		V . F. F. V				0.2			0,2	mA
	input voltage	CKB	V <sub>CC</sub> = MAX,	$V_1 = 5.5 V$				0.4			0.4	
	High-level	Any reset						20			20	
чн	-	CKA	V <sub>CC</sub> = MAX,	$V_{1} = 2.7 V$				40			40	μА
	input current	СКВ						80			80	
	Low-level	Any reset						-0.4			-0.4	
IIL.		CKA	V <sub>CC</sub> = MAX,	$V_1 = 0.4 \ V$				-2.4			-2.4	mA
	input current	CKB	1					-3.2			-3.2	
los	Short-circuit ou	tput current§	VCC = MAX			-20		-100	-20		-100	mA
	C		V = 444 V	C N 2	'LS90		9	15		9	15	
CC	ICC Supply current		V <sub>CC</sub> = MAX,	See Note 3	'LS92		9	15		9	15	mA

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 3: ICC is measured with all outputs open, both RO inputs grounded following momentary connection to 4,5 V, and all other inputs grounded.



 $<sup>\</sup>ddagger$ All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

<sup>§</sup>Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

 $<sup>\</sup>P$ QA outputs are tested at specified IOL plus the limit value of IIL for the CKB input. This permits driving the CKB input while maintaining full fan-out capability.

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### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

					•	S	N54LS9	3	S	3		
	PARAMET	ER	TE:	ST CONDITIONS	5'	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIH	High-level inpu	t voltage				2			2			٧
VIL	Low-level input	t voltage						0.7			8.0	٧
VIK	Input clamp vo	Itage	VCC = MIN,	l <sub>1</sub> = -18 mA				-1.5			-1.5	V
VOH	High-level outp	ut voltage	V <sub>CC</sub> = MIN, V <sub>IL</sub> = V <sub>IL</sub> max,	V <sub>IH</sub> = 2 V, 1 <sub>OH</sub> = -400 μA	λ.	2.5	3.4		2.7	3.4		٧
			VCC = MIN,	V <sub>IH</sub> = 2 V,	IOL = 4 mA¶		0.25	0.4		0.25	0.4	v
VOL	Low-level outp	ut voltage	VIL = VIL max		IOL = 8 mA¶					0.35	0.5	
	Input current	Any reset	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 7 V				0.1			0.1	mA
Ц	at maximum input voltage	CKA or CKB	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 5.5 V				0.2			0.2	
	High-level	Any reset		07.1/				20			20	μА
чн	input current	CKA or CKB	V <sub>CC</sub> = MAX,	$V_1 = 2.7 \text{ V}$				40			80	μΑ.
		Any reset						-0.4			-0.4	
IL	Low-level	CKA	V <sub>CC</sub> = MAX,	$V_I = 0.4 V$				-2.4			-2.4	mA
	input current	CKB	1					-1.6			-1.6	
los	Short-circuit or	utput current §	V <sub>CC</sub> = MAX			-20		-100	-20		-100	mA
Icc	Supply current		V <sub>CC</sub> = MAX,	See Note 3			9	15		9	15	mA

<sup>&</sup>lt;sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions

### switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$

	FROM	TO			'LS90			LS92			'LS93		UNIT
PARAMETER#	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	Olviii
	CKA	QΑ		32	42		32	42		32	42		MHz
f <sub>max</sub>	CKB	QB	1	16			16			16			
tPLH	OK A	0.	1		10	16		10	16		10	16	ns
<sup>t</sup> PHL	CKA	QA			12	18		12	18		12	18	
tPLH .	CKA	0			32	48		32	48		46	70	ns
tPHL	CKA	αD			34	50		34	50		46	70	
tPLH			CL = 15 pF,		10	16		10	16		10	16	ns
tPHL	СКВ	ΩB	R <sub>L</sub> = 2 kΩ		14	21		14	21		14	21	113
†PLH		_	See Figure 1		21	32		10	16		21	32	ns
tPHL	CKB	ac			23	35		14	21		23	35	113
tPLH					21	32		21	32		34	51	ns
<sup>1</sup> PHL	CKB	σD			23	35		23	35		34	51	
tPHL	Set-to-0	Any	1		26	40		26	40		26	40	ns
tPLH		Q <sub>A</sub> , Q <sub>D</sub>	1		20	30							ns
tPHL	Set-to-9	Q <sub>B</sub> , Q <sub>C</sub>	1		26	40							

<sup>#</sup>fmax = maximum count frequency



<sup>‡</sup>All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

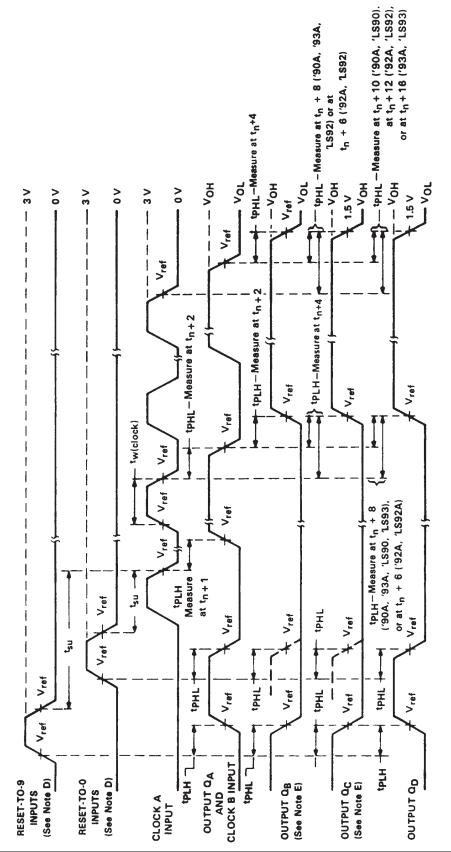
<sup>§</sup> Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

<sup>¶</sup>QA outputs are tested at specified IQL plus the limit value for IIL for the CKB input. This permits driving the CKB input while maintaining full fan-out capability.

NOTE 3: I<sub>CC</sub> is measured with all outputs open, both R<sub>0</sub> inputs grounded following momentary connection to 4.5 V, and all other inputs grounded.

 $tp_{LH} = propagation delay time, low-to-high-level output$ 

tpHL = propagation delay time, high-to-low-level output



NOTES: A. Input pulses are supplied by a generator having the following characteristics:

for 'LS90, 'LS92, 'LS93,  $t_f \le 15$  ns,  $t_f \le 5$  ns, PRR = 1 MHz, duty cycle = 50%,  $Z_{out} \approx 50$  ohms. for '90A, '92A, '93A, t<sub>f</sub> ≤ 5 ns, t<sub>f</sub> ≤ 5 ns, PRR = 1 MHz, duty cycle = 50%, Z<sub>out</sub> ≈ 50 ohms;

- CL includes probe and jig capacitance. All diodes are 1N3064 or equivalent.
- Each reset input is tested separately with the other reset at 4.5 V. BB CJ CJ UJ UL
  - Reference waveforms are shown with dashed lines.
- For '90A, '92A, and '93A;  $V_{ref} = 1.5 \text{ V}$ . For 'LS90, 'LS92, and 'LS93;  $V_{ref} = 1.3 \text{ V}$ .

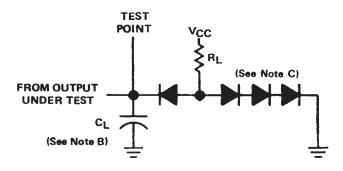
FIGURE 1A



PARAMETER MEASUREMENT INFORMATION

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#### PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT

- NOTES: A. Input pulses are supplied by a generator having the following characteristics: for '90A, '92A, '93A,  $t_r \le 5$  ns,  $t_f \le 5$  ns, PRR = 1 MHz, duty cycle = 50%,  $z_{out} \approx 50$  ohms; for 'LS90, 'LS92, 'LS93,  $t_r \le 15$  ns,  $t_f \le 5$  ns, PRR = 1 MHz, duty cycle = 50%,  $z_{out} \approx 50$  ohms.
  - B. C<sub>L</sub> includes probe and jig capacitance.
  - C. All diodes are 1N3064 or equivalent.
  - D. Each reset input is tested separately with the other reset at  $4.5\ V.$
  - E. Reference waveforms are shown with dashed lines.
  - F. For '90A, '92A, and '93A;  $V_{ref} = 1.5 \text{ V}$ . For 'LS90, 'LS92, and 'LS93;  $V_{ref} = 1.3 \text{ V}$ .

FIGURE 1B

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logic.ti.com	Military	www.ti.com/military
power.ti.com	Optical Networking	www.ti.com/opticalnetwork
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www.ti.com/lpw	Telephony	www.ti.com/telephony
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	dataconverter.ti.com dsp.ti.com interface.ti.com logic.ti.com power.ti.com microcontroller.ti.com	amplifier.ti.com dataconverter.ti.com dsp.ti.com dsp.ti.com interface.ti.com logic.ti.com power.ti.com microcontroller.ti.com www.ti.com/lpw  Audio Audio Audio Audio Automotive Broadband Digital Control Military Optical Networking Security Telephony Video & Imaging

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### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp (3)
7603201CA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
7603201DA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
7700101CA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
7700101DA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
JM38510/31501BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
JM38510/31501BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
JM38510/31502BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
JM38510/31502BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
SN5490AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN5492AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN54LS90J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
SN54LS93J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
SN7490AN	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN7492AN	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN7493AN	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74LS90D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS90DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS90DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS90DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS90DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS90DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS90N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS90NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS92D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS92DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS92DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS92N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS92N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74LS92NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS92NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS92NSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS92NSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS &	CU NIPDAU	Level-1-260C-UNLIM



#### PACKAGE OPTION ADDENDUM

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Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Packag Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp (3)
						no Sb/Br)		
SN74LS93D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS93DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS93DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS93DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS93DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS93DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS93N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS93N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74LS93NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS93NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS93NSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS93NSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ5490AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SNJ5490AW	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI
SNJ5492AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SNJ5492AW	OBSOLETE	CFP	W	14	_	TBD	Call TI	Call TI
SNJ54LS90J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
SNJ54LS90W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
SNJ54LS93J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
SNJ54LS93W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type

 $<sup>^{(1)}</sup>$  The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <a href="http://www.ti.com/productcontent">http://www.ti.com/productcontent</a> for the latest availability information and additional product content details.



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(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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### PACKAGE MATERIALS INFORMATION

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### TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS90DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS92NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74LS93DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS93NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

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\*All dimensions are nominal

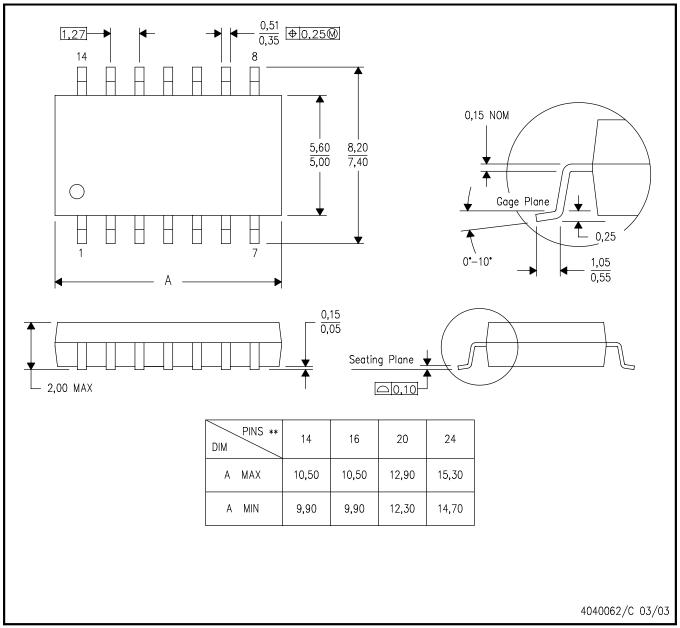
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS90DR	SOIC	D	14	2500	346.0	346.0	33.0
SN74LS92NSR	SO	NS	14	2000	346.0	346.0	33.0
SN74LS93DR	SOIC	D	14	2500	346.0	346.0	33.0
SN74LS93NSR	SO	NS	14	2000	346.0	346.0	33.0

### **MECHANICAL DATA**

### NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



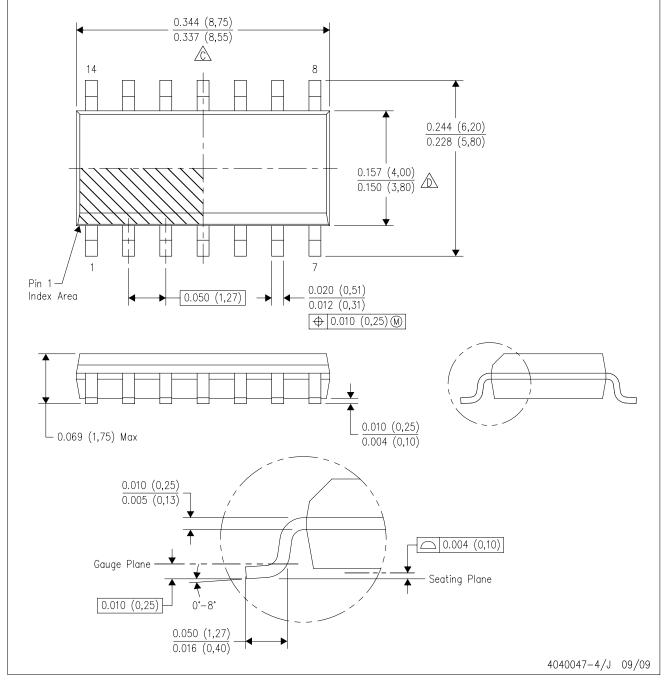
### 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## D (R-PDSO-G14)

### PLASTIC SMALL-OUTLINE PACKAGE

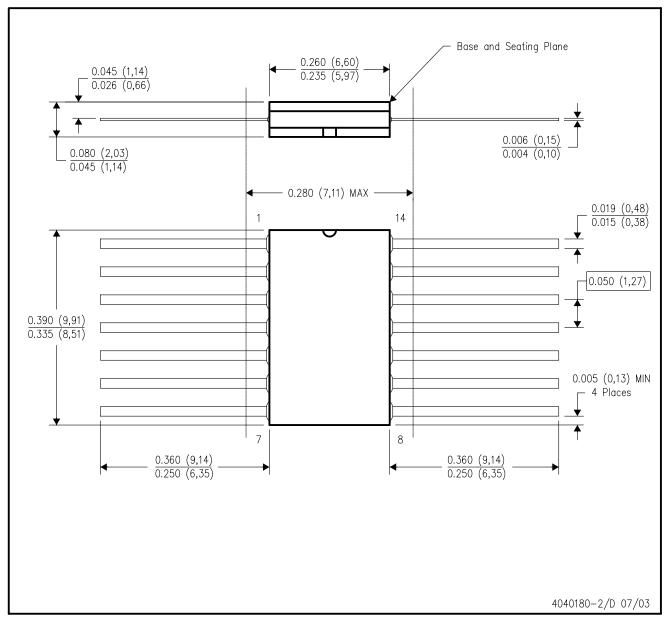


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AB.



# W (R-GDFP-F14)

### CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB



## N (R-PDIP-T\*\*)

### PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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